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Vishay Siliconix

COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY

V_{DS} (V) at T_J max.

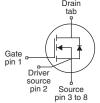
Q_q max. (nC)

Configuration

Q_{gs} (nC)

Q_{qd} (nC)

R_{DS(on)} typ. (Ω) at 25 °C



N-Channel MOSFET

0.090

650

51

16

8

Single

 $V_{GS} = 10 \overline{V}$

Gate	
Gate pin 1	

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
- High-intensity discharge (HID)
- Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION			
Package	PowerPAK 10 x 12		
Lead (Pb)-free and halogen-free	SIHK105N60EF-T1GE3		

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V _{DS}	600	V		
Gate-source voltage	V_{GS}	± 30	V		
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$		24	А	
	V_{GS} at 10 V $T_C = 100 ^{\circ}C$	I _D	15		
Pulsed drain current ^a	I _{DM}	61	İ		
Linear derating factor			1.14	W/°C	
Single pulse avalanche energy b	E _{AS}	154	mJ		
Maximum power dissipation		P _D	142	W	
Operating junction and storage temperature r	ange	T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125^{\circ}$		d. /dt	100	\//···	
Reverse diode dv/dt ^c		dv/dt	50	V/ns	

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.3 A
- c. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting $T_J = 25$ °C



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	=	50 ^c	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.88	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS			TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.56	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0	-	5.0	V
Gate-source leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zono della collega della consul		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A	-	0.090	0.105	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 10 V, I _D = 12 A	-	2.1	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 100 V, f = 200 kHz		-	2301	-	
Output capacitance	C _{oss}			-	81	-	
Reverse transfer capacitance	C _{rss}			-	1	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	85	-	pF -
Effective output capacitance, time related ^b	C _{o(tr)}			-	462	-	
Total gate charge	Qg			-	34	51	
Gate-source charge	Q_{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}, V_{DS} = 480 \text{ V}$		-	16	-	nC
Gate-drain charge	Q_{gd}			-	8	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, I_{D} = 15 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	31	62	- ns
Rise time	t _r			-	51	77	
Turn-off delay time	t _{d(off)}			-	40	80	
Fall time	t _f			-	30	60	
Gate input resistance	R_g	f = 1 MHz		0.4	0.8	1.6	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24	
Pulsed diode forward current	I _{SM}			-	-	61	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	102	292	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ $di/dt = 100 \text{ A/µs}, V_R = 400 \text{ V}$		-	0.6	1.2	μC
Reverse recovery current	I _{RRM}			_	13	-	Α

Notes

- d. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 400 V
- e. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 400 V
- f. When mounted on 1" x 1" FR4 board



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

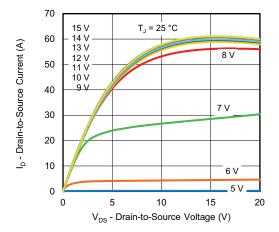


Fig. 1 - Typical Output Characteristics

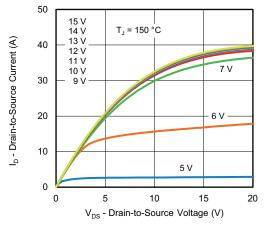


Fig. 2 - Typical Output Characteristics

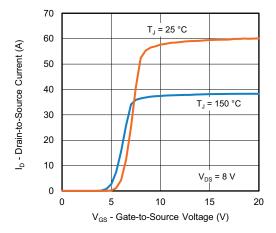


Fig. 3 - Typical Transfer Characteristics

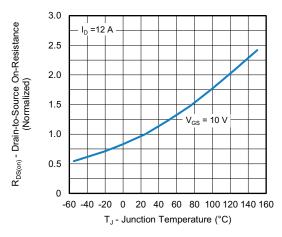


Fig. 4 - Normalized On-Resistance vs. Temperature

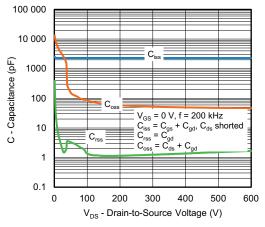


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

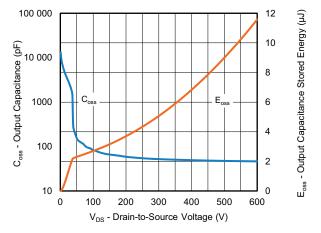


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



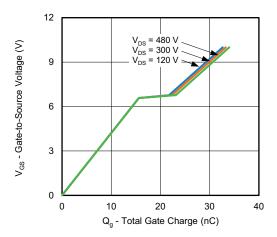


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

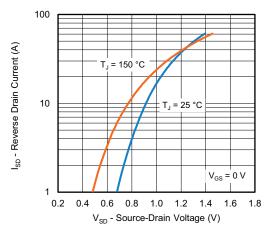


Fig. 8 - Typical Source-Drain Diode Forward Voltage

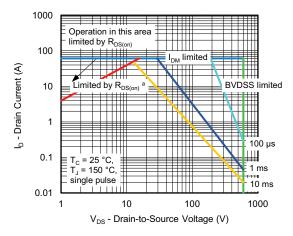


Fig. 9 - Maximum Safe Operating Area



a. $V_{GS} > minimum \ V_{GS}$ at which $R_{DS(on)}$ is specified

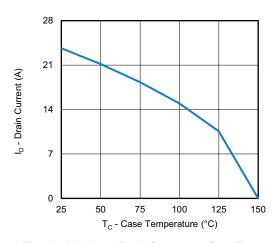


Fig. 10 - Maximum Drain Current vs. Case Temperature

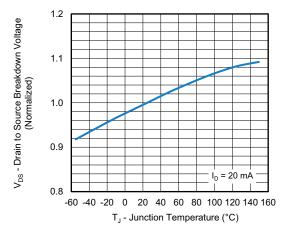


Fig. 11 - Temperature vs. Drain-to-Source Voltage



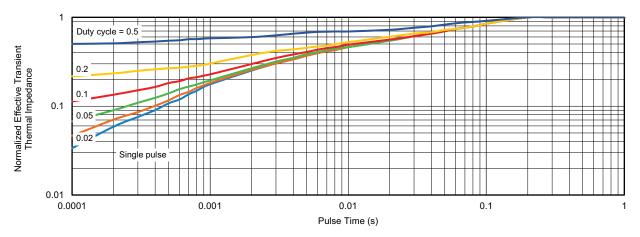


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

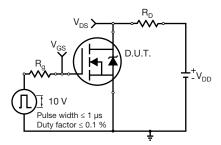


Fig. 13 - Switching Time Test Circuit

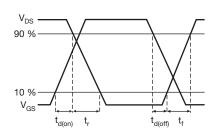


Fig. 14 - Switching Time Waveforms

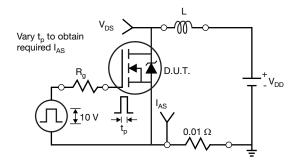


Fig. 15 - Unclamped Inductive Test Circuit

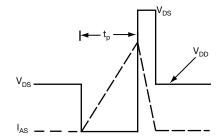


Fig. 16 - Unclamped Inductive Waveforms

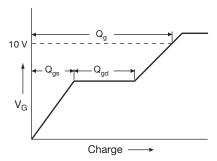


Fig. 17 - Basic Gate Charge Waveform

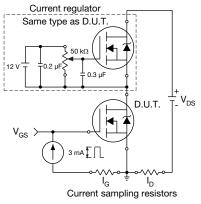
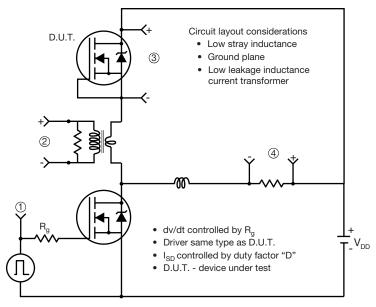


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



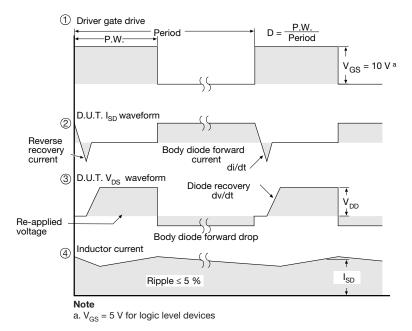


Fig. 19 - For N-Channel

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